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February 2006



# FFA40UP20DN Ultrafast Recovery Power Rectifier

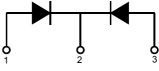
## Features

- Ultrafast with Soft Recovery : < 45ns (@I<sub>F</sub> = 20A)
- High Reverse Voltage : V<sub>RRM</sub> = 200V
- Avalanche Energy Rated
- Planar Construction

# Applications

- Output Rectifiers
- Switching Mode Power Supply
- Free-wheeling diode for motor application
- Power switching circuits





1. Anode 2. Cathode 3. Anode

1.Anode 2.Cathode 3.Anode

Absolute Maximum Ratings (per diode) T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>RRM</sub>	Peak Repetitive Reverse Voltage	200	V
V <sub>RWM</sub>	Working Peak Reverse Voltage	200	V
V <sub>R</sub>	DC Blocking Voltage	200	V
I <sub>F(AV)</sub>	Average Rectified Forward Current $@ T_C = T_C$	120°C 20	A
I <sub>FSM</sub>	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	200	A
T <sub>J,</sub> T <sub>STG</sub>	Operating Junction and Storage Temperature	- 65 to +150	°C

# **Thermal Characteristics**

Symbol	Parameter	Мах	Units	
$R_{ ext{ heta}JC}$	Maximum Thermal Resistance, Junction to Case	1.9	°C/W	

### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
F40UP20DN	FFA40UP20DNTU	TO-3PN	-	-	30

Symbol	Parameter		Min.	Тур.	Max.	Units
V <sub>FM</sub> *	I <sub>F</sub> = 20A I <sub>F</sub> = 20A	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	-	-	1.15 1.0	V V
I <sub>RM</sub> *	V <sub>R</sub> = 200V V <sub>R</sub> = 200V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	-	-	100 500	μΑ μΑ
t <sub>rr</sub>	$I_F = 1A$ , di/dt = 100A/µs, V <sub>CC</sub> = 30V $I_F = 20A$ , di/dt = 200A/µs, V <sub>CC</sub> = 130V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 25 °C	-	-	35 45	ns ns
t <sub>a</sub> t <sub>b</sub> Q <sub>rr</sub>	$I_F$ =20A, di/dt = 200A/µs, V <sub>CC</sub> = 130V	$T_{C} = 25 °C$ $T_{C} = 25 °C$ $T_{C} = 25 °C$ $T_{C} = 25 °C$	- -	11 13 21		ns ns nC
W <sub>AVL</sub>	Avalanche Energy (L = 40mH)	•	20	-	-	mJ

### Electrical Characteristics (per diode) T<sub>C</sub> = 25°C unless otherwise noted

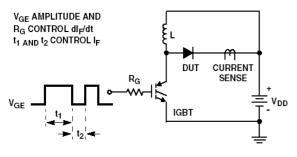
\* Pulse Test: Pulse Width=300 $\mu s,$  Duty Cycle=2%

$$\begin{split} &I_{MAX} = 1A \\ &L = 40mH \\ &R < 0.1\Omega \\ &E_{AVL} = 1/2LI^2 \left[ V_{R(AVL)} / (V_{R(AVL)} - V_{DD}) \right] \\ &Q_1 = IGBT (BV_{CES} > DUT V_{R(AVL)}) \end{split}$$

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Q1

### **Test Circuit and Waveforms**



trr TEST CIRCUIT

L R

+٩

 $V_{DD}$ 

V<sub>DD</sub>

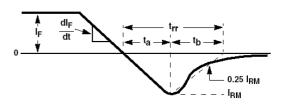
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CURRENT

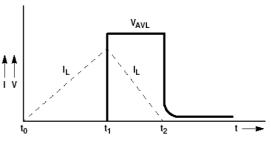
SENSE

DUT

AVALANCHE ENERGY TEST CIRCUIT



trr WAVEFORMS AND DEFINITIONS



AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

FFA40UP20DN Ultrafast Recovery Power Rectifier

#### **Typical Performance Characteristics** Figure 1. Typical Forward Voltage Drop 100 FORWARD CURRENT, I<sub>F</sub> [A] \_ = 75°C 10 T<sub>c</sub> = 125°C = 25°C 0.1 ∟ 0.4 0.6 0.8 1.0 1.2 1.4 1.6 FORWARD VOLTAGE, V<sub>F</sub> [V]



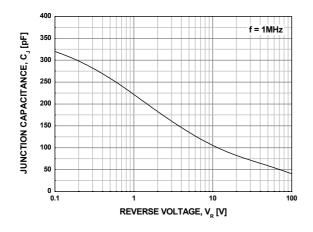


Figure 5. Typical Reverse Recovery Current

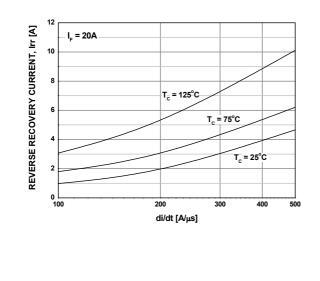


Figure 2. Typical Reverse Current

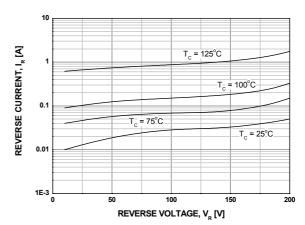


Figure 4. Typical Reverse Recovery Time

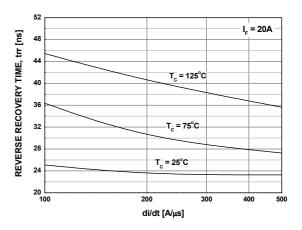
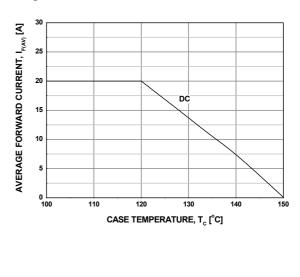
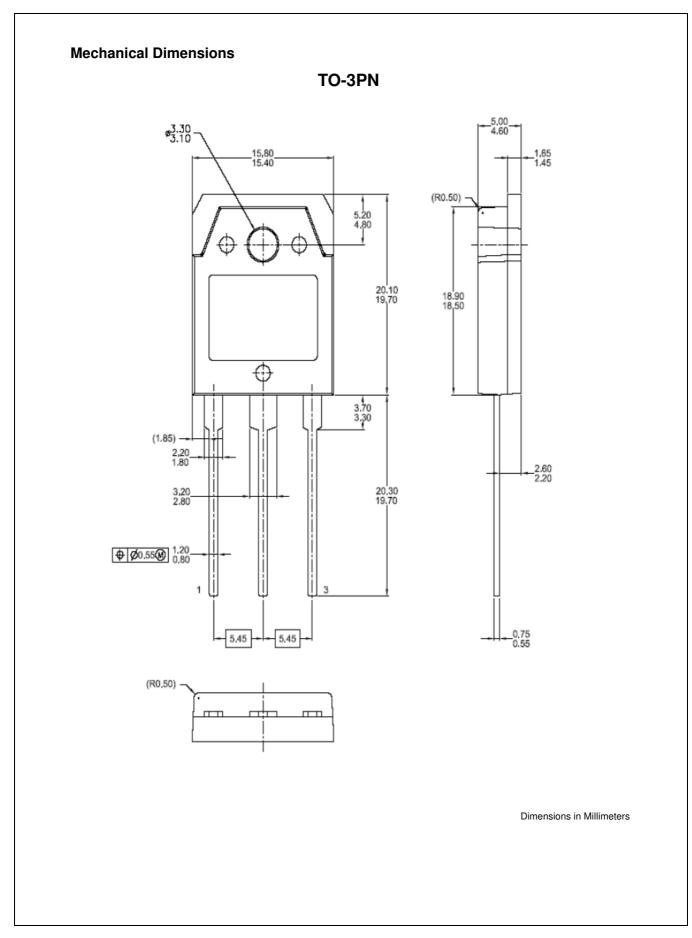


Figure 6. Forward Current Deration Curve





FFA40UP20DN Ultrafast Recovery Power Rectifier

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SuperSOT<sup>™</sup>-6 SuperSOT<sup>™</sup>-8 SyncFET<sup>™</sup> TCM<sup>™</sup> TinyLogic<sup>®</sup> TINYOPTO<sup>™</sup> TruTranslation<sup>™</sup> UHC<sup>™</sup> UHC<sup>™</sup> UltraFET<sup>®</sup> UniFET<sup>™</sup> VCX<sup>™</sup> Wire<sup>™</sup>

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